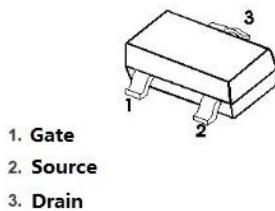


SOT-23N沟道30V漏-源电压MOS管
N-Channel 30V(D-S) Mosfet

产品特性总结Product Summary	
VDS	30V
RDS(on)(@VGS= 10V)	<25mΩ
RDS(on)(@VGS= 4.5V)	<28mΩ

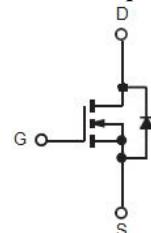
根据客户要求打印 According
to customer requirement

脚位定义Pin Definition**特征 Features**

- 低导通电阻Low Rds(on)@VGS= 10V
- 沟道功率MOS管TrenchFET Power MOSFET
- 无卤、RoHS认证Halogen-free、RoHS Compliant
- 表贴型封装Surface Mount Package

应用 Applications

- 便携式设备的直流/直流转换DC/DC Converter for Portable Devices
- 脉冲宽度调制器中的负载开关Load Switch for PWM
- 小型无刷直流马达驱动Small Brushless DC Motor Driver
- 便携式设备的充电开关Charging Switch for Portable Devices

等效电路 Equivalent circuit

极限值和温度特性(TA = 25°C 除非另有规定)

Maximum Ratings & Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
漏源电压Drain-Source Voltage	V _{DS}	30	V
栅源电压Gate-Source Voltage	V _{GS}	±12	V
漏极连续电流Continuous Drain Current	I _D	5.8	A
漏极脉冲电流Pulsed Drain Current (note 1)	I _{DM}	23	A
最大功耗Maximum Power Dissipation	P _D	1.5	W
结环热阻Thermal Resistance from Junction to Ambient (note 2)	R _{θJA}	100	°C/W
结温和存储温度Junction and Storage Temperature	T _J , T _{STG}	-50~+150	°C

电特性 (TA = 25°C 除非另有规定)

Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified).

参数 Parameters	符号 Symbol	测试条件 Test Condition	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
静态特性Static Characteristics						
漏源击穿电压 Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	30	--	--	V
零栅压漏极电流 Zero gate voltage drain current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V	--	--	1	μA
栅源漏电流Gate-body leakage current	I _{GSS}	V _{GS} = ± 12V, V _{DS} = 0V	--	--	±100	nA
栅源阈值电压 Gate threshold voltage (note 3)	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	0.5	1.0	1.5	V
漏源极导通电阻 Drain-source on-resistance (note 3)	R _{D(on)}	V _{GS} = 10V, I _D = 5A	--	20	25	mΩ
		V _{GS} = 4.5V, I _D = 4A	--	22	28	mΩ
		V _{GS} = 2.5V, I _D = 2A	--	32	40	mΩ
二极管正向电压 Diode forward voltage (note 3)	V _{SD}	I _S = 5A, V _{GS} = 0V	--	0.83	1.2	V

动态特性Dynamic Characteristics (note4)						
输入电容Input Capacitance	C _{iss}	V _{DS} = 15V, V _{GS} =0V, f=1MHz	--	650	--	pF
输出电容Output Capacitance	C _{oss}		--	54	--	pF
反向传输电容 Reverse Transfer Capacitance	C _{rss}		--	47	--	pF
开关特性Switching Characteristics (note 4)						
开启延迟时间Turn-on delay time	t _{d(on)}	V _{DD} = 15V, I _D = 5A, R _G = 3.3Ω, V _{GS} = 4.5V	--	7.5	--	ns
开启上升沿时间Turn-on rise time	t _r		--	18	--	ns
关断延迟时间Turn-off delay time	t _{d(off)}		--	36	--	ns
关断下降沿时间Turn-off fall time	t _f		--	5	--	ns
总栅极电荷Total Gate Charge	Q _g	V _{DS} = 15V, I _D =5A, V _{GS} =4.5V	--	6.2	--	nC
栅源电荷Gate-Source Charge	Q _{gs}		--	1.2	--	nC
栅漏电荷Gate-Drain Charge	Q _{gd}		--	1.9	--	nC

***Notes :**

1. Repetitive rating: Pulse width limited by maximum junction temperature
2. Surface Mounted on FR4 board, t≤10 sec.
3. Pulse test : Pulse width≤300μs, duty cycle≤2%.
4. Guaranteed by design, not subject to production.

典型特性曲线 Typical characteristics

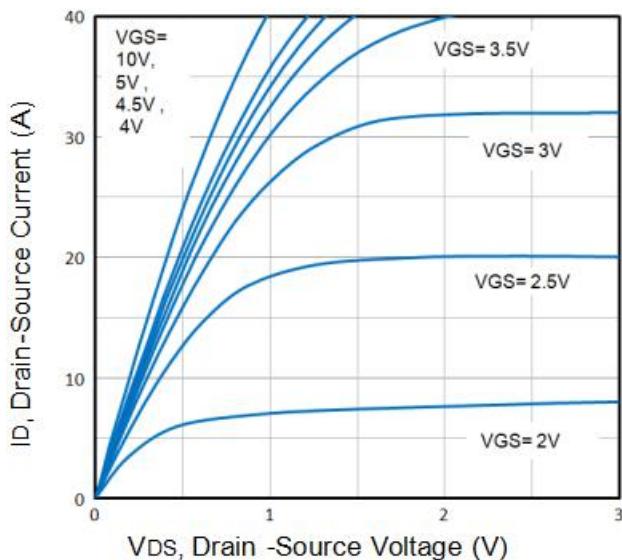


Fig1. Typical Output Characteristics

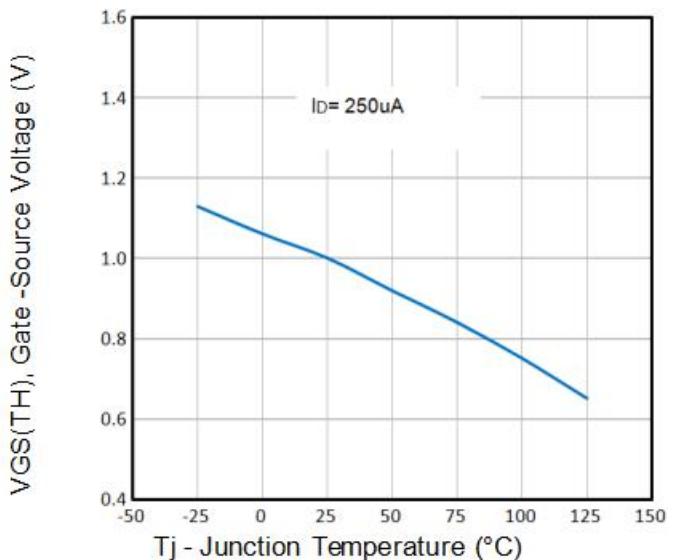


Fig2. Normalized Threshold Voltage Vs. Temperature

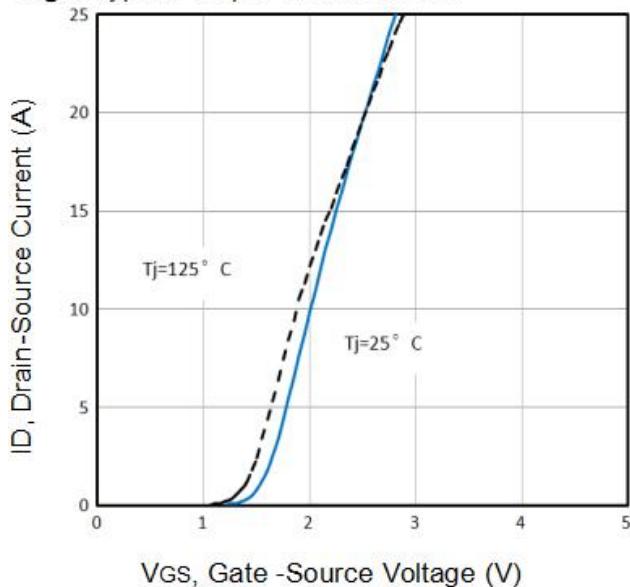


Fig3. Typical Transfer Characteristics

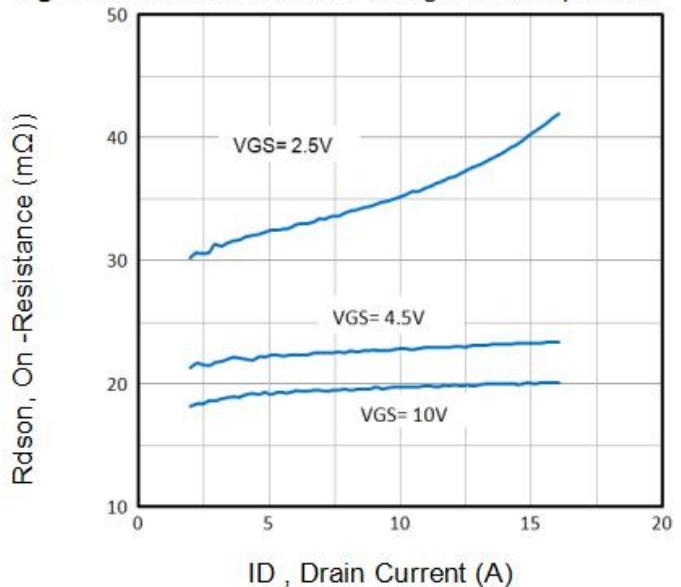


Fig4. On-Resistance vs. Drain Current and V_{GS}

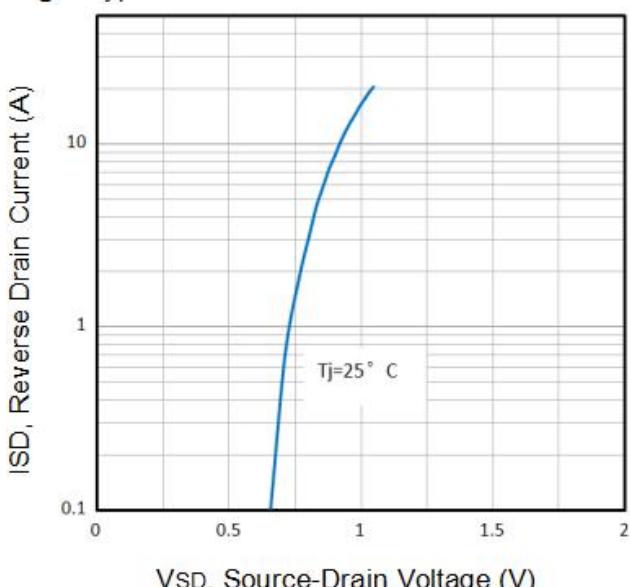


Fig5. Typical Source-Drain Diode Forward Voltage

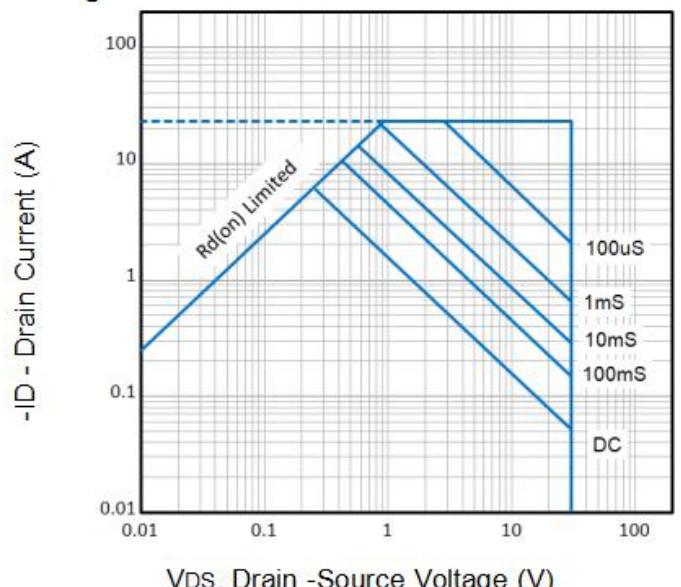
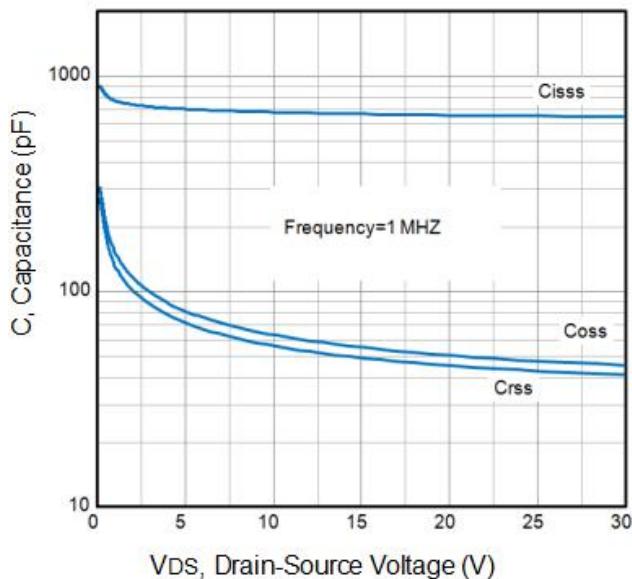
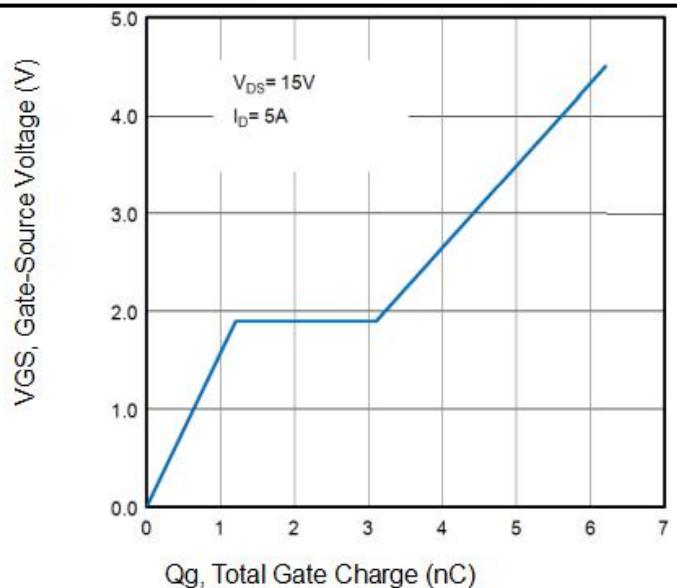
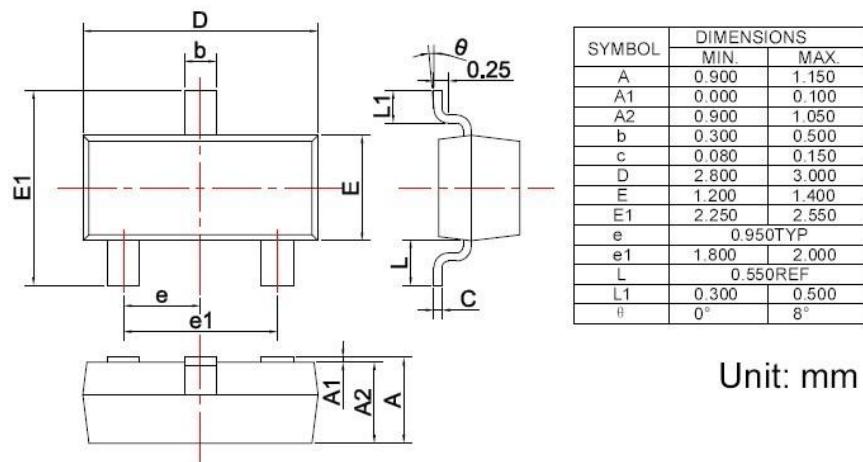


Fig6. Maximum Safe Operating Area

**Fig7.** Typical Capacitance Vs. Drain-Source Voltage**Fig8.** Typical Gate Charge Vs. Gate-Source Voltage

封装外形图 SOT-23 Package Outline Dimensions



焊盘设计参考PCB Design

